

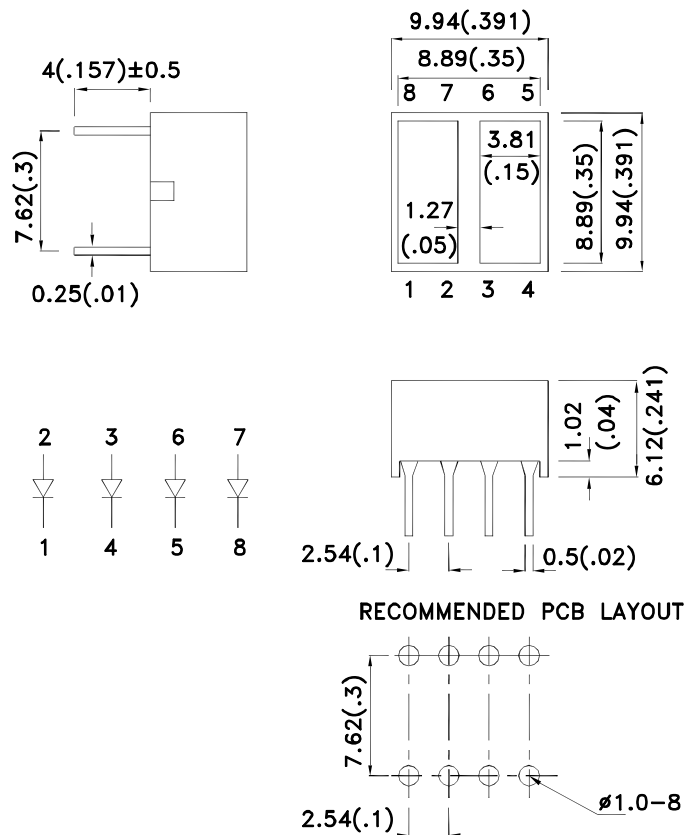
### Features

- Uniform light emitting area.
- Low current operation
- Easily mounted on P.C. boards.
- Flush mountable.
- Excellent on/off contrast.
- Can be used with panels and legend mounts.
- Categorized for luminous intensity.
- RoHS compliant.

### Description

The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

### Package Dimensions& Internal Circuit Diagram



#### Notes:

1. All dimensions are in millimeters (inches), Tolerance is  $\pm 0.25(0.01)$  unless otherwise noted.
2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.



## Selection Guide

| Part No.  | Dice                     | Lens Type      | Iv (mcd) [1]<br>@ 20mA |      |
|-----------|--------------------------|----------------|------------------------|------|
|           |                          |                | Min.                   | Typ. |
| KB2800SGD | Super Bright Green (GaP) | Green Diffused | 12                     | 27   |

Note:

1. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

| Symbol                | Parameter                | Device             | Typ. | Max. | Units | Test Conditions           |
|-----------------------|--------------------------|--------------------|------|------|-------|---------------------------|
| $\lambda_{peak}$      | Peak Wavelength          | Super Bright Green | 565  |      | nm    | I <sub>F</sub> =20mA      |
| $\lambda_D$ [1]       | Dominant Wavelength      | Super Bright Green | 568  |      | nm    | I <sub>F</sub> =20mA      |
| $\Delta\lambda_{1/2}$ | Spectral Line Half-width | Super Bright Green | 30   |      | nm    | I <sub>F</sub> =20mA      |
| C                     | Capacitance              | Super Bright Green | 15   |      | pF    | V <sub>F</sub> =0V;f=1MHz |
| V <sub>F</sub> [2]    | Forward Voltage          | Super Bright Green | 2.2  | 2.5  | V     | I <sub>F</sub> =20mA      |
| I <sub>R</sub>        | Reverse Current          | Super Bright Green |      | 10   | uA    | V <sub>R</sub> =5V        |

Notes:

1.Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

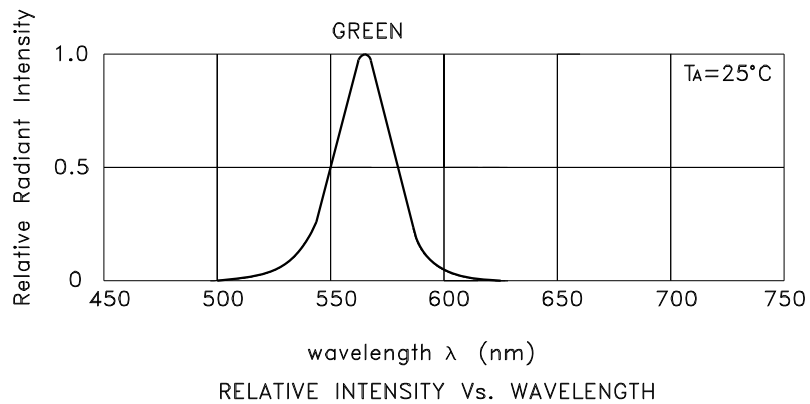
## Absolute Maximum Ratings at TA=25°C

| Parameter                       | Super Bright Green    | Units |
|---------------------------------|-----------------------|-------|
| Power dissipation               | 62.5                  | mW    |
| DC Forward Current              | 25                    | mA    |
| Peak Forward Current [1]        | 140                   | mA    |
| Reverse Voltage                 | 5                     | V     |
| Operating / Storage Temperature | -40°C To +85°C        |       |
| Lead Solder Temperature[2]      | 260°C For 3-5 Seconds |       |

Notes:

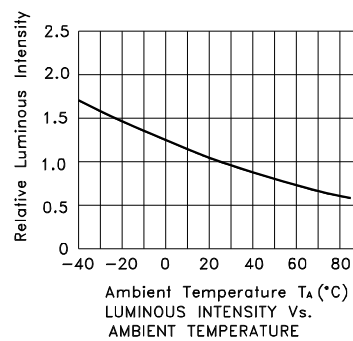
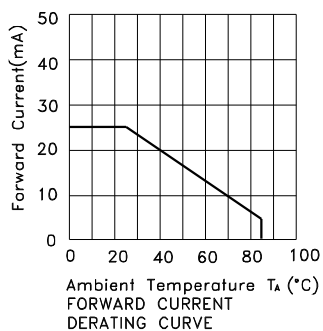
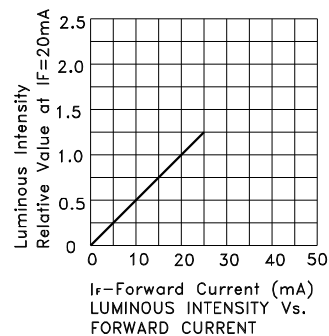
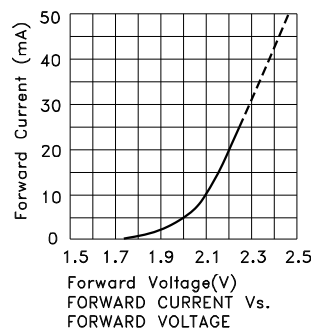
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.



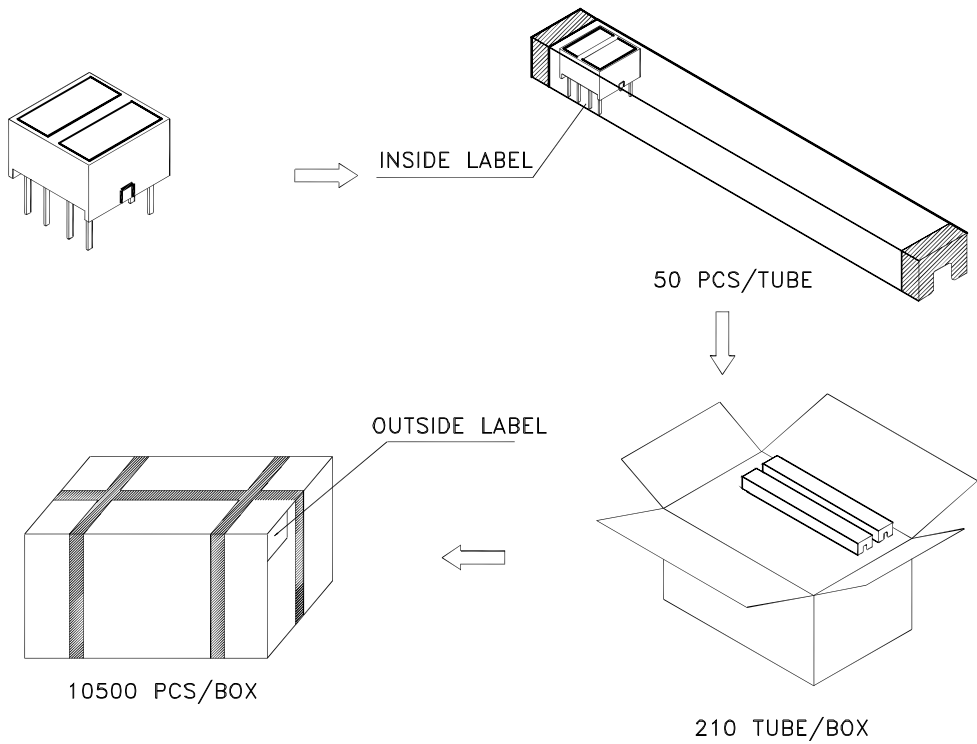
## Super Bright Green

## KB2800SGD



## PACKING & LABEL SPECIFICATIONS

KB2800SGD



Inside Label On IC-tube

|                   |                      |                            |      |
|-------------------|----------------------|----------------------------|------|
| <b>Kingbright</b> | TYPE: KB2800xxx      | PASSED<br>xx xx xx<br>FQCX | Date |
|                   | QTY: 50 PCS CODE: xx |                            |      |
|                   |                      |                            |      |
| XXXXXXXXXX-XXXX   |                      | Number OF FQC              |      |
| LOT NO.           |                      | RoHS Compliant             |      |

Outside Label On Box

|                |    |                           |              |
|----------------|----|---------------------------|--------------|
| XXXXXX         |    | Bin Code                  | Number OF QA |
| KB2800xxx      |    |                           |              |
| 10500 PCS      | XX | QAx<br>xx xx xx<br>PASSED | Date         |
|                |    |                           |              |
| RoHS Compliant |    |                           |              |

## THROUGH HOLE DISPLAY MOUNTING METHOD

### Lead Forming

Do not bend the component leads by hand without proper tools.  
The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.



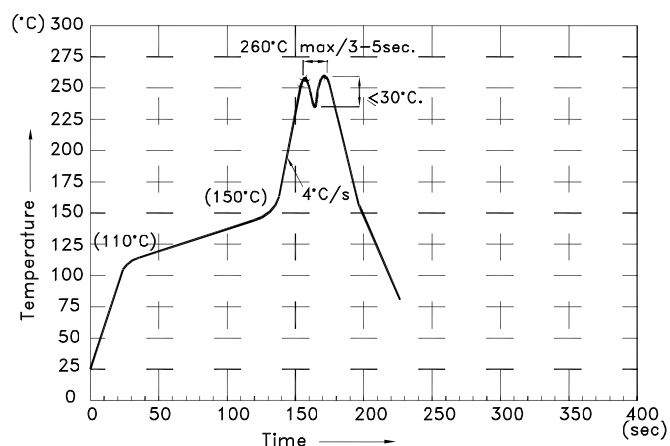
### Installation

- 1.The installation process should not apply stress to the lead terminals.
- 2.When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.



## DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



### NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering , the PCB top-surface temperature should be kept below 105°C
- 5.No more than once.

## Soldering General Notes:

- a. Through-hole displays are incompatible with reflow soldering.
- b. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

## CLEANING

1. Mild "no-clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts. And the devices should not be washed for more than one minute.

## CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



## Данный компонент на территории Российской Федерации

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